AMENDMENT UNDER 37 C.F.R. § 1.116 U.S. APPLICATION NO. 10/694,392 ATTORNEY DOCKET NO. Q77903

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## **AMENDMENTS TO THE CLAIMS**

This listing of claims will replace all prior versions and listings of claims in the application:

## LISTING OF CLAIMS:

Claims 1. – 55. (canceled)

56. (currently amended): A method of fabricating thin film transistors, comprising: forming at least one semi-conductive film on a substrate; immersing said substrate in a dopant; and

independently tilting a plurality of tiltable beam steering elements to deliver delivering a laser beam to a plurality of independently selectable location on said substrate with a plurality of independently tiltable beam steering elements to induce a doping reaction between said dopant and said semi-conductive film at said independently selectable locations.

- 57. (previously presented): The method claimed in claim 56, wherein said semi-conductive film comprises a semiconductor film.
- 58. (previously presented): The method claimed in claim 56, wherein said semi-conductive film comprises silicon.
- 59. (previously presented): The method claimed in claim 58, wherein said semi-conductive film is deposited on an insulating substrate.
- 60. (original): The method claimed in claim 59 and wherein said insulating substrate comprises glass.